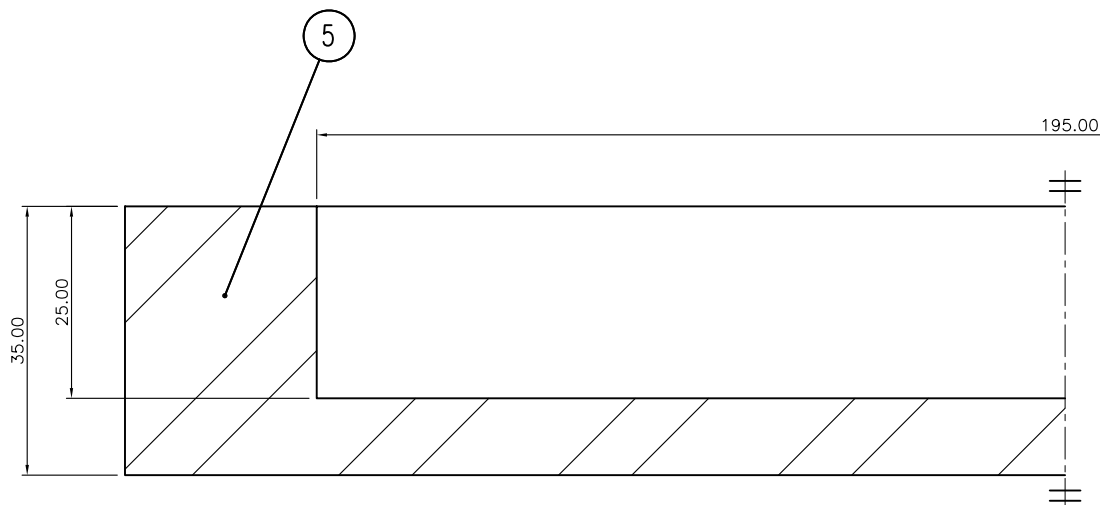
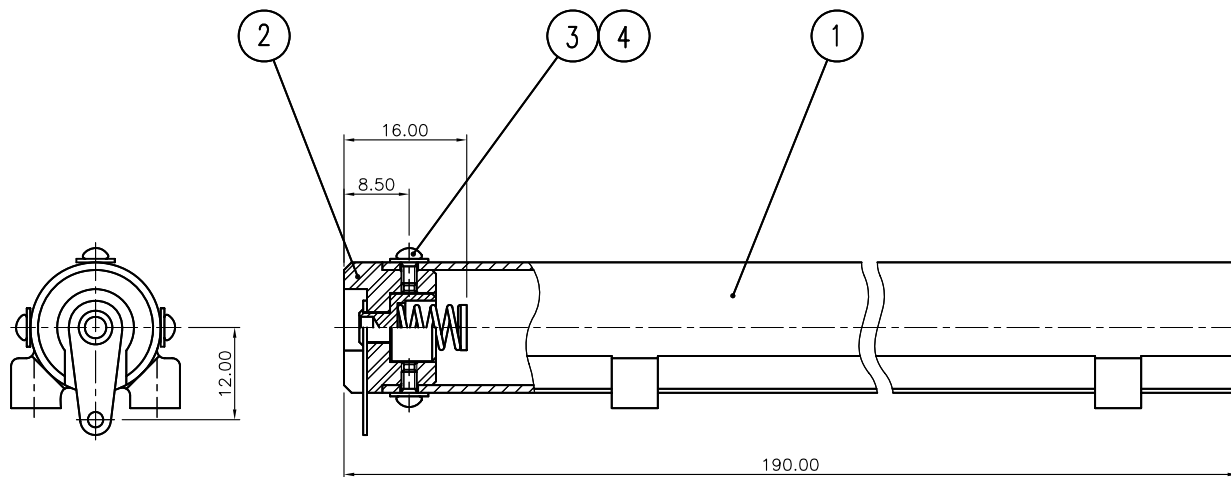


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration			1996.06.14.
1	와셔 별도 추가		Y.H.CHOI	2002.11.25.
2	[설번처리NO.201308-0001] 조립성 개선 (나사 변경)	E.H.KIM	I.C.KIM	2013.08.08.



* 주 기
1. 본도와 같이 품번 ①번에 품번 ②번을 조립 후
품번 ③을 이용하여 체결 한다.

5	충격 완충재	1	PE-FOAM		CPA00045-N/1 (XS002)
4	와셔	4	MBsBD	Nickel Plate	DWA00089-5/1
3	작은 나사	4	SUS303	M2x3mm	DBT00217-N/1 DBT00217-N/1 (S100)
2	램, 전기식 조립체	1	-		CN01957-7/1 (K750-810)
1	전자봉	1	ALUMINUM	Black Anodizing	DBD01993-5/1 (FH010)
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2013. 08. 08.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		 BATTERY ASSY aluminum
		DRAWN BY	E.H.KIM	
FINISH		SCALE	1.5/1	A3 DWG NO. CN01703-7/1 (K975-016-000) REVISION 2 SHEET 1 of 1
		UNIT	mm	